

Small Signal MOSFET

115 mAmps, 60 Volts

N-Channel SOT-23

- We declare that the material of product are Halogen Free and compliance with RoHS requirements.
- ESD Protected:1000V
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|---|------------------------------------|-----------------------------------|
| Drain-Source Voltage | V _{DSS} | 60 | V _{dc} |
| Drain-Gate Voltage ($R_{GS} = 1.0 \text{ M}\Omega$) | V _{DGR} | 60 | V _{dc} |
| Drain Current – Continuous $T_C = 25^\circ\text{C}$ (Note 1.) $T_C = 100^\circ\text{C}$ (Note 1.) – Pulsed (Note 2.) | I _D I _D I _{DM} | ± 115 ± 75 ± 800 | mA _{dc} |
| Gate-Source Voltage – Continuous – Non-repetitive ($t_p \leq 50 \mu\text{s}$) | V _{GGS} V _{GSM} | ± 20 ± 40 | V _{dc} V _p |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------------------------|----------------|-------------|
| Total Device Dissipation FR-5 Board (Note 3.) $T_A = 25^\circ\text{C}$ Derate above 25°C | P _D | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | R _{θJA} | 556 | °C/W |
| Total Device Dissipation Alumina Substrate,(Note 4.) $T_A = 25^\circ\text{C}$ Derate above 25°C | P _D | 300 2.4 | mW mW/°C |
| Thermal Resistance, Junction to Ambient | R _{θJA} | 417 | °C/W |
| Junction and Storage Temperature | T _J , T _{stg} | -55 to +150 | °C |

- The Power Dissipation of the package may result in a lower continuous drain current.
- Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.
- FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- Alumina = $0.4 \times 0.3 \times 0.025$ in 99.5% alumina.

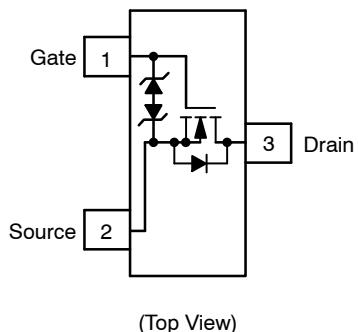
ORDERING INFORMATION

| Device | Marking | Shipping |
|------------------------------|---------|-------------------|
| L2N7002LT1G S-L2N7002LT1G | 702 | 3000 Tape & Reel |
| L2N7002LT3G S-L2N7002LT3G | 702 | 10000 Tape & Reel |

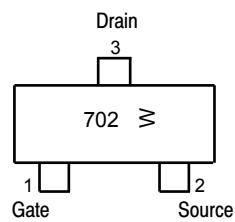
**L2N7002LT1G
S-L2N7002LT1G**



Simplified Schematic



MARKING DIAGRAM & PIN ASSIGNMENT



702 = Device Code
W = Month Code

L2N7002LT1G , S-L2N7002LT1G
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|---------------|-----|-----|------------|-----------------|
| OFF CHARACTERISTICS | | | | | |
| Drain–Source Breakdown Voltage ($V_{GS} = 0$, $I_D = 10 \mu\text{Adc}$) | $V_{(BR)DSS}$ | 60 | — | — | Vdc |
| Zero Gate Voltage Drain Current ($V_{GS} = 0$, $V_{DS} = 60 \text{ Vdc}$) | I_{DSS} | — | — | 1.0 500 | μAdc |
| Gate–Body Leakage Current, Forward ($V_{GS} = 20 \text{ Vdc}$) | I_{GSSF} | — | — | 1 | μAdc |
| Gate–Body Leakage Current, Reverse ($V_{GS} = -20 \text{ Vdc}$) | I_{GSSR} | — | — | -1 | μAdc |

ON CHARACTERISTICS (Note 2.)

| | | | | | |
|---|---------------------|------------------|----------------------|----------------------------|-------|
| Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 250 \mu\text{Adc}$) | $V_{GS(\text{th})}$ | 1.0 | 1.6 | 2 | Vdc |
| On–State Drain Current ($V_{DS} \geq 2.0 \text{ V}_{DS(\text{on})}$, $V_{GS} = 10 \text{ Vdc}$) | $I_{D(\text{on})}$ | 500 | — | — | mA |
| Static Drain–Source On–State Voltage ($V_{GS} = 10 \text{ Vdc}$, $I_D = 500 \text{ mAAdc}$) ($V_{GS} = 5.0 \text{ Vdc}$, $I_D = 50 \text{ mAAdc}$) | $V_{DS(\text{on})}$ | — — | — — | 3.75 0.375 | Vdc |
| Static Drain–Source On–State Resistance ($V_{GS} = 10 \text{ V}$, $I_D = 500 \text{ mAAdc}$) $T_C = 25^\circ\text{C}$ $T_C = 125^\circ\text{C}$ ($V_{GS} = 5.0 \text{ Vdc}$, $I_D = 50 \text{ mAAdc}$) $T_C = 25^\circ\text{C}$ $T_C = 125^\circ\text{C}$ | $r_{DS(\text{on})}$ | — — — — | 1.4 — 1.8 — | 7.5 13.5 7.5 13.5 | Ohms |
| Forward Transconductance ($V_{DS} \geq 2.0 \text{ V}_{DS(\text{on})}$, $I_D = 200 \text{ mAAdc}$) | g_{FS} | 80 | — | — | mmhos |

DYNAMIC CHARACTERISTICS

| | | | | | |
|--|-----------|---|-----|-----|----|
| Input Capacitance ($V_{DS} = 25 \text{ Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{ MHz}$) | C_{iss} | — | 17 | 50 | pF |
| Output Capacitance ($V_{DS} = 25 \text{ Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{ MHz}$) | C_{oss} | — | 10 | 25 | pF |
| Reverse Transfer Capacitance ($V_{DS} = 25 \text{ Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{ MHz}$) | C_{rss} | — | 2.5 | 5.0 | pF |

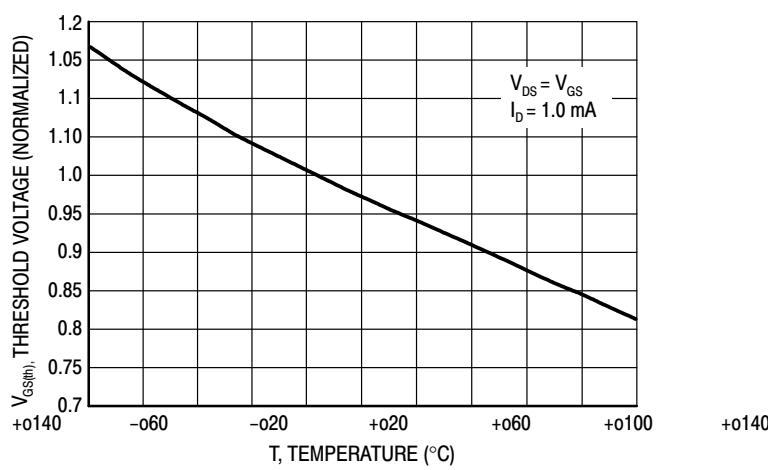
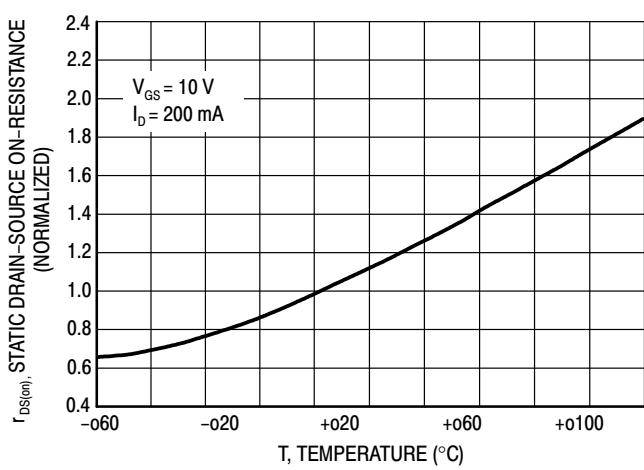
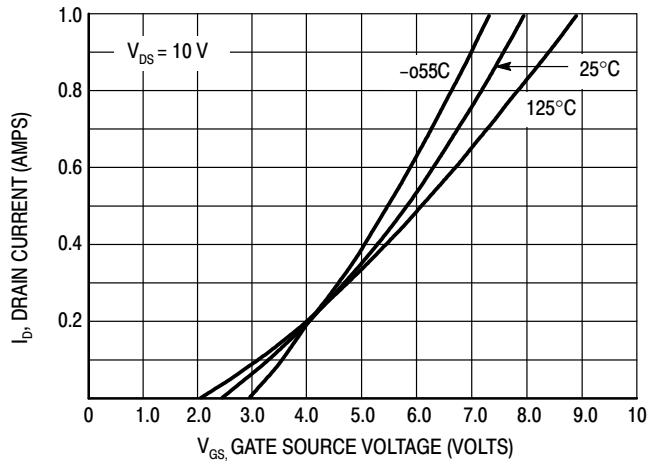
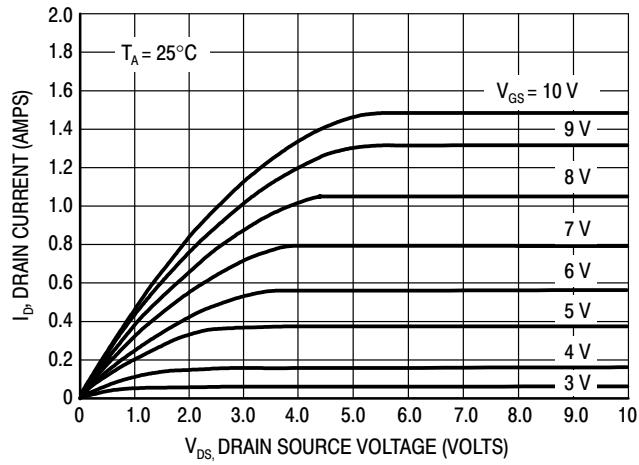
SWITCHING CHARACTERISTICS (Note 2.)

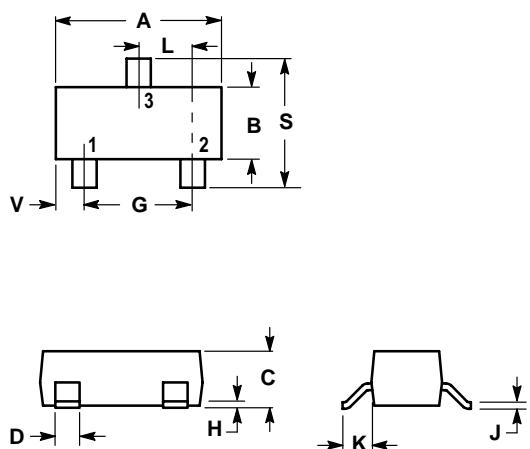
| | | | | | | |
|---------------------|--|---------------------|---|----|----|----|
| Turn–On Delay Time | $(V_{DD} = 25 \text{ Vdc}, I_D \approx 500 \text{ mAAdc}, R_G = 25 \Omega, R_L = 50 \Omega, V_{gen} = 10 \text{ V})$ | $t_{d(\text{on})}$ | — | 7 | 20 | ns |
| Turn–Off Delay Time | | $t_{d(\text{off})}$ | — | 11 | 40 | ns |

BODY–DRAIN DIODE RATINGS

| | | | | | |
|--|----------|---|---|------|-------|
| Diode Forward On–Voltage ($I_S = 115 \text{ mAAdc}$, $V_{GS} = 0 \text{ V}$) | V_{SD} | — | — | -1.5 | Vdc |
| Source Current Continuous (Body Diode) | I_S | — | — | -115 | mAAdc |
| Source Current Pulsed | I_{SM} | — | — | -800 | mAAdc |

2. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

L2N7002LT1G , S-L2N7002LT1G
TYPICAL ELECTRICAL CHARACTERISTICS


L2N7002LT1G , S-L2N7002LT1G
SOT-23

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|--------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.1102 | 0.1197 | 2.80 | 3.04 |
| B | 0.0472 | 0.0551 | 1.20 | 1.40 |
| C | 0.0350 | 0.0440 | 0.89 | 1.11 |
| D | 0.0150 | 0.0200 | 0.37 | 0.50 |
| G | 0.0701 | 0.0807 | 1.78 | 2.04 |
| H | 0.0005 | 0.0040 | 0.013 | 0.100 |
| J | 0.0034 | 0.0070 | 0.085 | 0.177 |
| K | 0.0140 | 0.0285 | 0.35 | 0.69 |
| L | 0.0350 | 0.0401 | 0.89 | 1.02 |
| S | 0.0830 | 0.1039 | 2.10 | 2.64 |
| V | 0.0177 | 0.0236 | 0.45 | 0.60 |

